CLC115 Quad, Closed-Loop Monolithic Buffer

General Description

The CLC115 is a high performance, closed-loop, quad buffer designed for high density applications requiring a low-cost-perchannel solution to buffering high-frequency signals. The CLC115's high performance includes a 700MHz small signal bandwidth (0.5Vpp) and a 2700V/ μ s slew rate while requiring only 11mA quiescent current per channel. Signal fidelity is maintained with low harmonic distortion (– 62dBc 2nd and 3rd harmonics at 20MHz), and wide channel separation (60dB crosstalk at 10MHz).

Featuring a unique closed-loop design, the CLC115 offers true unity-gain stability and very low output impedance plus a 60mA per channel output drive capability. The CLC115 is ideally suited for buffering video signals with its 0.08%/0.04° differential gain and phase performance at 3.58MHz. Applications such as analog multiplexing and high-speed A/D converters will benefit from the CLC115's high signal fidelity.

The CLC115 offers a low-cost-per-channel solution to high-speed buffering with four high-performance, closed-loop buffers integrated in one 14-pin package.

Constructed using an advanced, complimentary bipolar process and National's proven current feedback architectures, the CLC115 is available in several versions to meet a variety of requirements.

CLC115AJP	-40°C to +85°C	8-pin plastic DIP
CLC115AJE	-40°C to +85°C	8-pin plastic SOI
CLC115ALC	-40°C to +85°C	dice
CLC115AMC	-55°C to +125°C	dice qualified to I
		MIL-STD-883. Le

8-pin plastic SOIC dice dice qualified to Method 5008, MIL-STD-883, Level B MIL-STD-883, Level B

Contact factory for other packages and DESC SMD number.

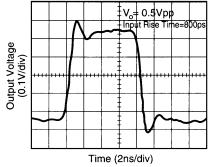
Features

- Closed-loop, quad buffer
- 700MHz small-signal bandwidth
- 270V/µs slew rate
- 0.08%/0.04° differential gain/phase
- 60dB channel isolation (10MHz)
- -62dBc 2nd and 3rd harmonics at 20MHz
- 60mA current output per channel

Applications

- Multi-channel video distribution
- Video switching buffers
- High-speed analog multiplexing
- Channelized EW
- High-density buffering
- Instrumentation amps
- Active filters

Small Signal Pulse Response



Pinout

Vin1	ر	13 12 11 10 9	Vout1 + V _{cc} Vout2 NC Vout3 - V _{cc}
Vin4		8	- v _{cc} Vout4

June 1999

CLC115 Electrical Characteristics ($V_{cc} = \pm 5V$, $R_L = 100\Omega$; unless specified)							
PARAMETERS	CONDITIONS	TYP	P MAX AND MIN RATINGS		UNITS	SYMBOL	
Ambient Temperature	CLC115AJ	+ 25°C	– 40°C	+ 25°C	+ 85°C		
FREQUENCY DOMAIN R	ESPONSE						
- 3dB bandwidth	$V_{out} < 0.5 V_{pp}$	700	400	400	300	MHz	SSBW
	$V_{out} < 4V_{pp}$	270	200	200	150	MHz	LSBW
gain flatness	V _{out} < 0.5V _{pp}						
flatness	DC to 30MHz ¹	± 0.0	± 0.1	± 0.1	± 0.1	dB	GFL
peaking	30MHz to 200MHz	0.4	1.4	1.0	1.0	dB	GFPH
rolloff	30MHz to 200MHz	0.0	0.5	0.5	0.5	dB	GFRH
differential gain	4.43MHz, 150 Ω load	0.08	0.25	0.15	0.15	%	DG
differential phase	4.43MHz, 150 Ω load	0.04	0.08	0.08	0.08	0	DP
crosstalk (all hostile)	10MHz	60	57	57	57	dB	ХТ
TIME DOMAIN RESPONS	Ε						
rise and fall time	4V step	1.4	2.0	2.0	2.4	ns	TRS
settling time to 0.1%	2V step	12	17	17	17	ns	TS
overshoot	4V step input t _{rise} < 4ns	5	15	12	12	%	OS1
	input t _{rise} > 4ns	0	2	2	2	%	OS2
slew rate	1 100	2700	2200	2200	1800	V/µs	SR
DISTORTION AND NOISE	RESPONSE						
2nd harmonic distortion	2V _{pp} , 20MHz	- 62	- 45	- 47	- 47	dBc	HD2
3rd harmonic distortion	2V _{pp} , 20MHz	- 62	- 53	- 53	- 50	dBc	HD3
equivalent noise input	- · pp,						
noise floor	>1MHz	- 157	- 155	- 155	- 154	dBm _{1Hz}	SNF
STATIC DC PERFORMANCE							
small signal gain	no load	0.995	0.97	0.99	0.99	V/V	GA
integral endpoint linearity	\pm 2V, full scale	0.2	1.4	0.5	0.5	%	ILIN
*output offset voltage		±2	± 17	± 9	± 9	mV	VIO
average temperature	e coefficient	± 25	± 100	_	± 50	μV/°C	DVIO
*input bias current		± 8	± 35	± 20	± 20	μΑ	IBN
average temperature	e coefficient	± 66	± 187		± 125	nA/°C	DIBN
power supply rejection rat		54	46	48	46	dB	PSRR
*supply current	total, no load	45	61	61	61	mA	ICC
MISCELLANEOUS PERF							
input resistance	UNWANCE	750	100	450	450	kΩ	RIN
input capacitance		1.6	2.2	2.2	2.2	pF	CIN
output resistance	DC	1.0	4.5	2.0	2.0	Ω	RO
output voltage range	no load	± 4.0	± 3.8	± 3.9	± 3.9	V	VO
output voltage range	$R_L = 100\Omega$	± 4.0 ± 3.7	± 3.6 ± 2.2	± 3.9 ± 3.4	± 3.9	v	VOL
output vollage range	$n_{\rm L} = 10032$	± 3.7 ± 60	± 2.2 ± 25	± 3.4 ± 48	± 3.0 ± 30	mA	
			1 - 20	+ 40			

Min/max ratings are based on product characterization and simulation. Individual parameters are tested as noted. Outgoing quality levels are determined from tested parameters.

NOTES:

* AJ

Absolute Maximum Ratings				
V _{cc}	± 7V			
V _{cc} I _{out} output is short circuit protected to				
ground, however, maximum reliability	1			
is obtained if Iout does not exceed	80mA			
input voltage	± V _{cc} + 150°C			
maximum junction temperature	+ 150°C			
operating temperature range	_			
	to + 85°C			
	o + 150°C			
lead temperature (soldering 10 sec)	+ 300°C			
ESD	≥4000V			

Miscellaneous Ratings

100% tested at	+ 25°C.
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note 1: Specification is guaranteed for $(50\Omega \le R_L \le 200\Omega)$.

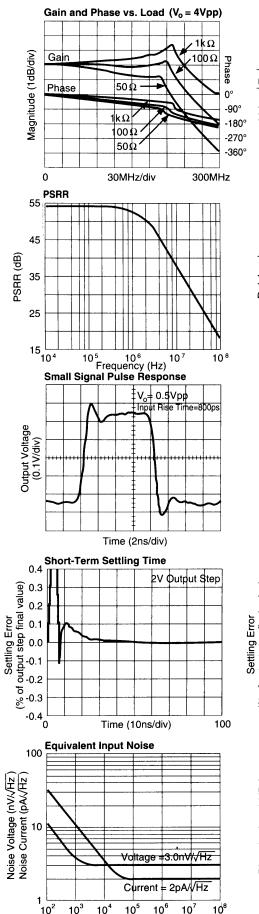
Package Thermal Resistance				
Package	θ _{JC}	θ _{JA}		
Plastic (AJP) Surface Mount (AJE)	55°C/W 45°C/W	105°C/W 115°C/W		

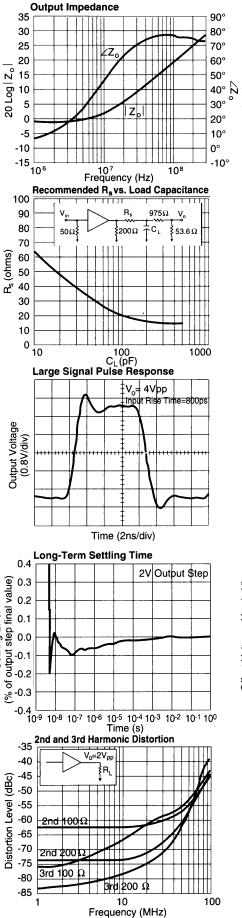
Reliability Information

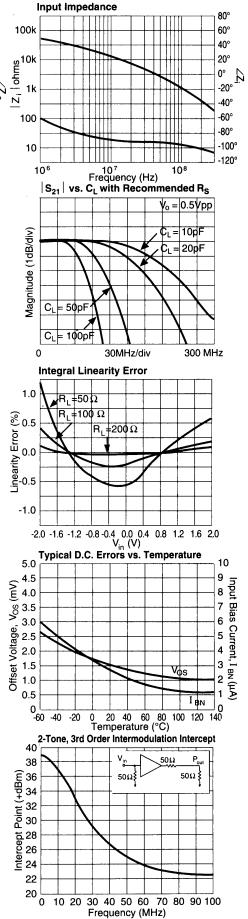
Transistor Count

64

CLC115 Typical Performance Characteristics (T_A = +25°, V_{CC} = ±5V, R_L = 100Ω; unless specified)







Frequency (Hz)

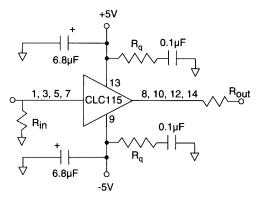


Figure 1: recommended circuit

PC Board Layout and Circuit Design

For optimum performance, high frequency devices demand a good printed circuit board layout. A ground plane and power supply bypassing with good highfrequency ceramic capacitors in close proximity to the supply pins is essential. Second harmonic distortion can be improved by ensuring equal current return paths for both the positive and negative supplies.

The dominant pole, i.e. the high-frequency compensation of the CLC115, is set by the load resistance, R_L. Ideally, each buffer of the CLC115 should see a 100 Ω load at high frequency to ensure stability. An unterminated channel is undercompensated and will exhibit gain at several hundred megahertz. Signal coupling may occur between channels through the common power supply connections. Any resonance in the power supply can lead to oscillations in the unterminated or undercompensated channel.

In order to compensate and to guarantee the stability of the four CLC115 channels, each must be terminated with a 100 Ω resistance to ground. If a dc load is not desired, a two picofarad capacitor can be inserted between the 100 Ω load resistor and ground, as shown in Figure 2.

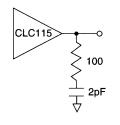


Figure 2: AC load

If the above load conditions are not feasible for your design, the power supply resonance must be addressed. Chip capacitors have less parasitic inductance than leaded ceramic capacitors. The use of 0.1µF chip capacitors mounted immediately adjacent to the power supply pins eliminates the resonance which can lead to oscillations. If chip capacitors are not used, then the only other means to eliminate the possibility of oscillation caused by power supply resonance is to 'de-Q' the resonant structure. 'De-Q'ing is particularly necessary while using leaded capacitors and can be achieved by inserting a 10 Ω resistor, $R_q,$ in series with the 0.1 μF bypass capacitor, as shown in Figure 1. The insertion of the 'de-Q'ing resistor will reduce frequency response peaking as well as the tendency toward oscillation when driving a load resistance greater than 100Ω , but will increase harmonic distortion by approximately 2dB.

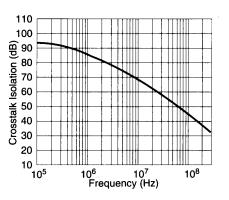


Figure 3: all-hostile crosstalk isolation

Crosstalk is strongly dependent on board layout. Closely spaced signal traces on the circuit board will degrade crosstalk due to intertrace capacitance. It is recommended that unused package pins (2,4,6,11) be connected to the ground plane for better isolation at the device pins. Similarly, crosstalk can be improved by using a grounded guard-trace between signal lines. This will reduce the distributed capacitance between signal lines.

Two graphs show the effects of crosstalk. All-hostile crosstalk is measured by driving three of the four buffers simultaneously while observing the fourth, undriven channel. Figure 3, "All-Hostile Crosstalk Isolation", shows this effect as a function of input signal frequency. The load for all four channels of the CLC115 is 100Ω . Figure 4, "Most Susceptible Channel-to-Channel Pulse Coupling", describes one effect of crosstalk when one channel is driven with a $4V_{pp}$ step (tr=5ns) while the output of the undriven channel is measured. From Figure 3 it can be seen that crosstalk improves as the signal frequency is reduced. Similarly, the pulse coupling crosstalk will improve as the time increases.

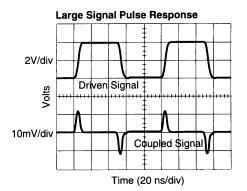


Figure 4: most susceptible channel-to-channel pulse coupling

Unused Buffers

The output of any unused buffers must be terminated in 100Ω to ground, as discussed above. It is recommended that unused buffer inputs be terminated in 50Ω to ground.

Evaluation Board

An evaluation board for the CLC115 is available. This board may be ordered as part CLC730023.

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